



#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on) max</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C
60V	44mΩ @ V <sub>GS</sub> = 10V	5.0A
607	60mΩ @ V <sub>GS</sub> = 4.5V	4.3A

## **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(on)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

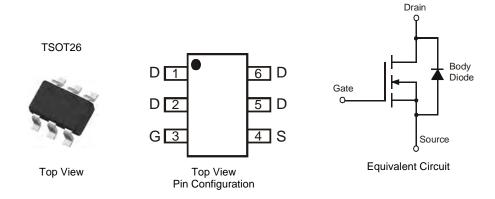
- DC-DC Converters
- Power management functions
- Backlighting

### **Features and Benefits**

- 100% Unclamped Inductive Switch (UIS) test in production
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Lead, Halogen, and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe.
  Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (approximate)



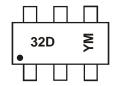
### Ordering Information (Note 3)

Part Number	Case	Packaging
DMN6040SVT-7	TSOT26	3,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



32D = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010) M = Month (ex: 9 = September)

Date Code Key

Year	2010	)	2011		2012	20	13	2014		2015		2016
Code	Х		Υ		Z	1	4	В		С		D
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

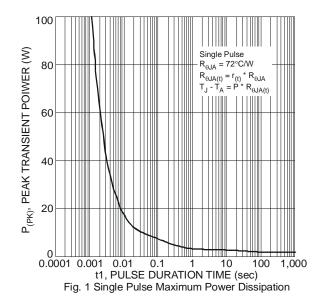


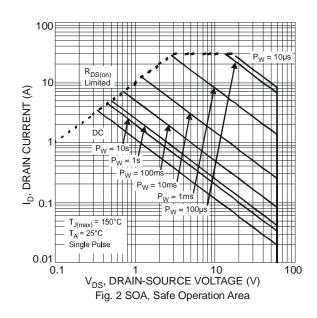
## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	60	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
State T <sub>A</sub> =		T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	5.0 4.0	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	t<10s	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	6.3 5.0	А
Continuous Desis Correct (Note 5) V	Steady State	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	4.3 3.4	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = 5V	t<10s	T <sub>A</sub> = 25°C T <sub>A</sub> = 70°C	I <sub>D</sub>	5.4 4.3	А
Maximum Body Diode Forward Current (Note 5)	I <sub>S</sub>	2.1	Α		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I <sub>DM</sub>	30	Α		
Avalanche Current (Note 6) L = 0.1mH	I <sub>AR</sub>	14.2	Α		
Avalanche Energy (Note 6) L = 0.1mH	E <sub>AR</sub>	10	mJ		

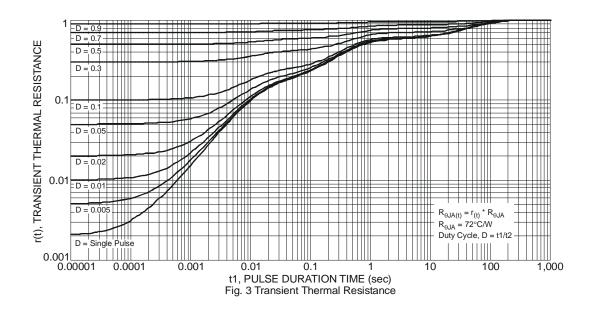
# Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units
Total Dawer Dissipation (Note 4)	T <sub>A</sub> = 25°C	D	1.2	W
Total Power Dissipation (Note 4)	T <sub>A</sub> = 70°C	$P_{D}$	0.75	VV
Thermal Begistenes, Junction to Ambient (Note 4)	Steady state	D	106	°C/W
Thermal Resistance, Junction to Ambient (Note 4)	t<10s	$R_{\theta JA}$	69	°C/W
Total Power Dissipation (Note 5)	T <sub>A</sub> = 25°C	Pn	1.8	W
Total Fower Dissipation (Note 5)	T <sub>A</sub> = 70°C	PD	1.1	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	68	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	44	°C/W
Thermal Resistance, Junction to Case (Note 5)		$R_{ heta JC}$	20	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C









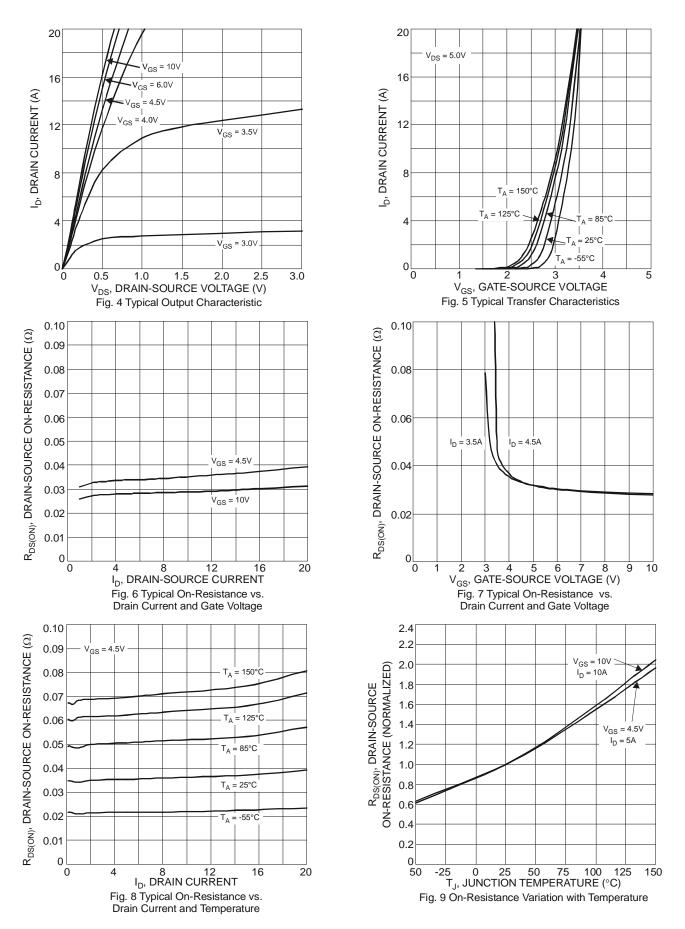
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	1 2 3		- 71-			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	100	nA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		_	30	44	mΩ	$V_{GS} = 10V, I_D = 4.3A$
Static Diain-Source On-Resistance	R <sub>DS</sub> (ON)	_	35	60	1115.2	$V_{GS} = 4.5V, I_D = 4A$
Forward Transfer Admittance	Y <sub>fs</sub>	_	4.5	_	S	$V_{DS} = 10V, I_D = 4.3A$
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)	•					
Input Capacitance	C <sub>iss</sub>		1287	_		V 05V V 0V
Output Capacitance	Coss	_	57	_	pF	$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	44	_		1 = 1.0IVII 12
Gate Resistance	R <sub>G</sub>	_	1.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	22.4	_		
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	10.4	_	nC	V 20V L 4.2A
Gate-Source Charge	$Q_{gs}$	_	4.9	_	IIC	$V_{DS} = 30V, I_{D} = 4.3A$
Gate-Drain Charge	$Q_{gd}$	_	3.0	_		
Turn-On Delay Time	t <sub>D(on)</sub>	_	6.6	_		
Turn-On Rise Time	t <sub>r</sub>	_	8.1	_	nS	$V_{GS} = 10V, V_{DD} = 30V, R_G = 6\Omega,$
Turn-Off Delay Time	t <sub>D(off)</sub>	_	20.1	_	$I_D = 4.3A$	$I_D = 4.3A$
Turn-Off Fall Time	t <sub>f</sub>	_	4.0	_		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	_	18	_	nS	I <sub>S</sub> = 4.3A, dI/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	_	11.9	_	nC	I <sub>S</sub> = 4.3A, dI/dt = 100A/µs

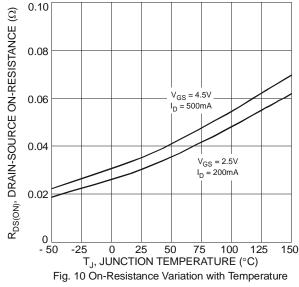
Notes:

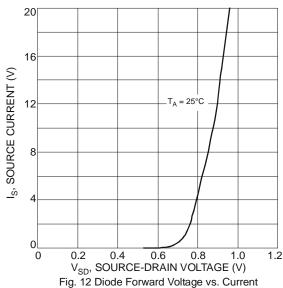
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
  Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 6.  $I_{AR}$  and  $E_{AR}$  rating are based on low frequency and duty cycles to keep  $T_J = 25^{\circ}C$
- 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.
- DMN6040SVT 3 of 7 March 2012 © Diodes Incorporated www.diodes.com Document number: DS35562 Rev. 10 - 2

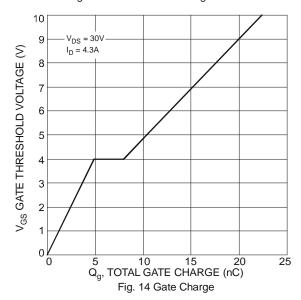












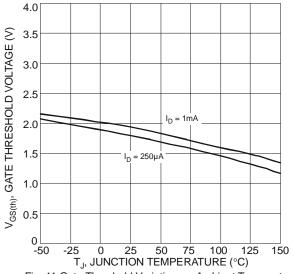
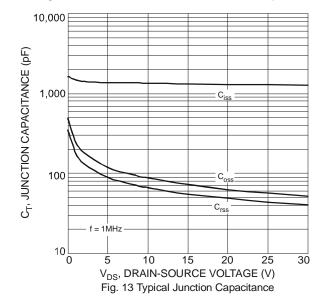
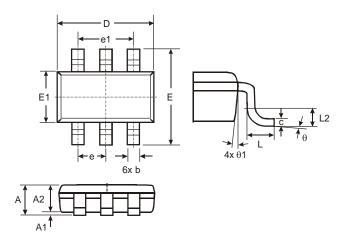


Fig. 11 Gate Threshold Variation vs. Ambient Temperature



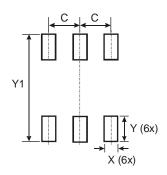


## **Package Outline Dimensions**



TSOT26								
Dim	Min	Max	Тур					
Α		1.00	-					
A1	0.01	0.10	-					
A2	0.84	0.90	_					
D			2.90					
Е			2.80					
E1			1.60					
b	0.30	0.45	1					
C	0.12	0.20	1					
e			0.95					
e1	_	_	1.90					
١	0.30	0.50	_					
L2			0.25					
θ	0°	8°	4°					
θ1	4°	12°						
All Dimensions in mm								

# **Suggested Pad Layout**



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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